

# **BUK9Y30-75B**

# N-channel TrenchMOS logic level FET Rev. 04 — 10 April 2008

Product data sheet

# **Product profile**

### 1.1 General description

Logic level N-channel enhancement mode Field-Effect Transistor (FET) in a plastic package using TrenchMOS technology. This product has been designed and qualified to the appropriate AEC standard for use in automotive critical applications.

### 1.2 Features and benefits

- Low conduction losses due to low on-state resistance
- Suitable for logic level gate drive sources
- Q101 compliant
- Suitable for thermally demanding environments due to 175 °C rating

### 1.3 Applications

- 12 V, 24 V and 42 V loads
- General purpose power switching
- Automotive systems
- Motors, lamps and solenoids

### 1.4 Quick reference data

Table 1. **Quick reference** 

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$V_{DS}$	drain-source voltage	$T_j \ge 25~^{\circ}C;~T_j \le 175~^{\circ}C$	-	-	75	V
I <sub>D</sub>	drain current	$V_{GS} = 5 \text{ V}; T_{mb} = 25 \text{ °C};$ see <u>Figure 1</u> and <u>4</u>	-	-	34	Α
P <sub>tot</sub>	total power dissipation	T <sub>mb</sub> = 25 °C; see <u>Figure 2</u>	-	-	85	W
Avalanch	ne ruggedness					
E <sub>DS(AL)S</sub>	non-repetitive drain-source avalanche energy	$I_D$ = 34 A; $V_{sup} \le 75$ V; $R_{GS}$ = 50 $\Omega$ ; $V_{GS}$ = 5 V; $T_{j(init)}$ = 25 °C; unclamped	-	-	78	mJ
Dynamic	characteristics					
$Q_{GD}$	gate-drain charge	$V_{GS} = 5 \text{ V}; I_D = 25 \text{ A};$ $V_{DS} = 60 \text{ V}; T_j = 25 ^{\circ}\text{C};$ see Figure 14	-	9	-	nC
Static ch	aracteristics					
R <sub>DSon</sub>	drain-source on-state resistance	$V_{GS} = 5 \text{ V}; I_D = 15 \text{ A};$ $T_j = 25 ^{\circ}\text{C}; \text{ see } \frac{\text{Figure } 12}{13} \text{ and } \frac{13}{13}$	-	25	30	mΩ



# 2. Pinning information

Table 2. Pinning

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	S	source	mb	D
2	S	source		
3	S	source		g_(
4	G	gate	[4]	
mb	D	mounting base; connected to drain	1 2 3 4 SOT669 (LFPAK)	mbb076 S

# 3. Ordering information

Table 3. Ordering information

Type number	Package	ckage						
	Name	Description	Version					
BUK9Y30-75B	LFPAK	plastic single-ended surface-mounted package (LFPAK); 4 leads	SOT669					

# 4. Limiting values

Table 4. Limiting values

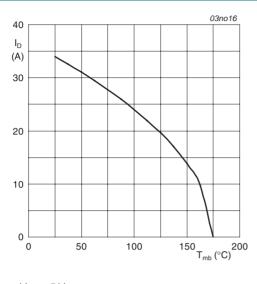
In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
$V_{DS}$	drain-source voltage	$T_j \ge 25 \text{ °C}; T_j \le 175 \text{ °C}$	-	75	V
$V_{DGR}$	drain-gate voltage	$R_{GS}$ = 20 k $\Omega$ ; $T_{mb} \ge$ 25 °C; $T_{mb} \le$ 175 °C	-	75	V
$V_{GS}$	gate-source voltage		-15	15	V
$I_D$	drain current	$T_{mb} = 25  ^{\circ}\text{C};  V_{GS} = 5  \text{V};  \text{see}  \frac{\text{Figure 1}}{}  \text{and}  \frac{4}{}$	-	34	Α
		$T_{mb} = 100 ^{\circ}\text{C}$ ; $V_{GS} = 5 ^{\circ}\text{V}$ ; see Figure 1	-	24	Α
$I_{DM}$	peak drain current	$T_{mb}$ = 25 °C; $t_p \le 10 \mu s$ ; pulsed; see Figure 4	-	137	Α
P <sub>tot</sub>	total power dissipation	T <sub>mb</sub> = 25 °C; see <u>Figure 2</u>	-	85	W
T <sub>stg</sub>	storage temperature		-55	175	°C
Tj	junction temperature		-55	175	°C
Source-	drain diode				
Is	source current	$T_{mb} = 25  ^{\circ}C$	-	34	Α
I <sub>SM</sub>	peak source current	$t_p \le 10 \ \mu s;$ pulsed; $T_{mb}$ = 25 °C	-	137	Α
Avalanc	he ruggedness				
E <sub>DS(AL)S</sub>	non-repetitive drain-source avalanche energy	$I_D = 34 \text{ A; V}_{sup} \leq 75 \text{ V; R}_{GS} = 50 \ \Omega; V_{GS} = 5 \text{ V;} \\ T_{j(init)} = 25 \ ^{\circ}\text{C; unclamped}$	-	78	mJ
E <sub>DS(AL)R</sub>	repetitive drain-source avalanche energy	see Figure 3	[1][2] - [3]	-	J

<sup>[1]</sup> Single-pulse avalanche rating limited by maximum junction temperature of 175 °C.

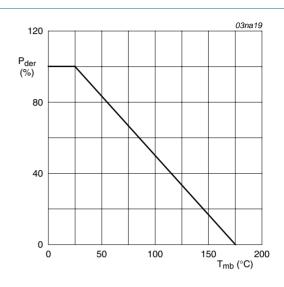
<sup>[2]</sup> Repetitive avalanche rating limited by average junction temperature of 170 °C.

<sup>[3]</sup> Refer to application note AN10273 for further information.



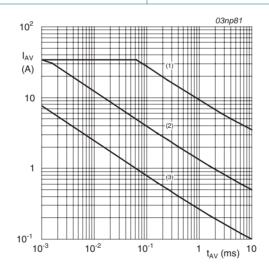
 $V_{GS} \ge 5 V$ 

Fig 1. Normalized continuous drain current as a function of mounting base temperature



$$P_{der} = \frac{P_{tot}}{P_{tot(25\,^{\circ}C)}} \times 100\,\%$$

Fig 2. Normalized total power dissipation as a function of mounting base temperature



- (1) Single-pulse;  $T_i = 25 \, ^{\circ}C$ .
- (2) Single-pulse;  $T_i = 150 \, ^{\circ}\text{C}$ .
- (3) Repetitive.

Fig 3. Single-shot and repetitive avalanche rating; avalanche current as a function of avalanche period

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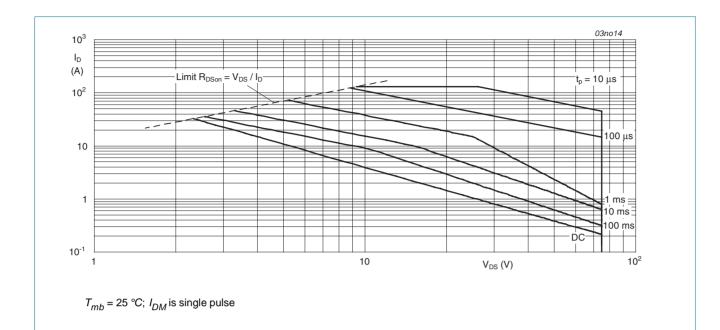


Fig 4. Safe operating area; continuous and peak drain currents as a function of drain-source voltage

# 5. Thermal characteristics

Table 5. Thermal characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$R_{th(j-mb)}$	thermal resistance from junction to mounting base	see Figure 5	-	-	1.8	K/W

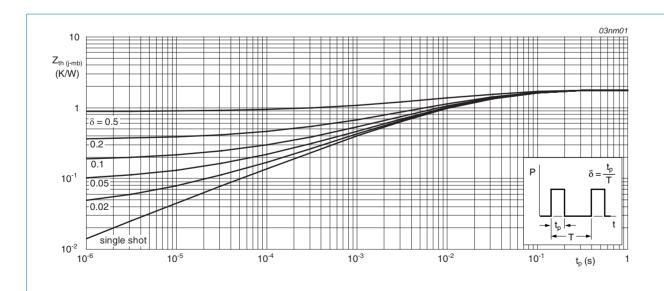


Fig 5. Transient thermal impedance from junction to mounting base as a function of pulse duration

# 6. Characteristics

Table 6. Characteristics

Table 6.	Characteristics					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static cha	racteristics					
$V_{(BR)DSS}$	drain-source breakdown voltage	$I_D = 0.25 \text{ mA}; V_{GS} = 0 \text{ V};$ $T_j = 25 ^{\circ}\text{C}$	75	-	-	V
		$I_D = 0.25 \text{ mA}; V_{GS} = 0 \text{ V};$ $T_j = -55 \text{ °C}$	70	-	-	V
$V_{GS(th)}$	gate-source threshold voltage	$I_D = 1$ mA; $V_{DS} = V_{GS}$ ; $T_j = 175$ °C; see <u>Figure 11</u>	0.5	-	-	V
		$I_D$ = 1 mA; $V_{DS}$ = $V_{GS}$ ; $T_j$ = 25 °C; see <u>Figure 11</u>	1.1	1.5	2	V
		$I_D = 1$ mA; $V_{DS} = V_{GS}$ ; $T_j = -55$ °C; see <u>Figure 11</u>	-	-	2.3	V
I <sub>DSS</sub> drain leakage current		$V_{DS} = 75 \text{ V}; V_{GS} = 0 \text{ V};$ $T_j = 175 ^{\circ}\text{C}$	-	-	500	μΑ
		$V_{DS} = 75 \text{ V}; V_{GS} = 0 \text{ V}; T_j = 25 ^{\circ}\text{C}$	-	0.02	1	μΑ
I <sub>GSS</sub> gate	gate leakage current	$V_{DS} = 0 \text{ V}; V_{GS} = +15 \text{ V};$ $T_j = 25 ^{\circ}\text{C}$	-	2	100	nA
		$V_{DS} = 0 \text{ V}; V_{GS} = -15 \text{ V};$ $T_j = 25 \text{ °C}$	-	2	100	nA
R <sub>DSon</sub>	drain-source on-state	$V_{GS} = 4.5 \text{ V}; I_D = 15 \text{ A}; T_j = 25 ^{\circ}\text{C}$	-	-	34	mΩ
	resistance	$V_{GS} = 5 \text{ V; } I_D = 15 \text{ A; } T_j = 175 \text{ °C;}$ see Figure 12 and 13	-	-	72	mΩ
		$V_{GS} = 5 \text{ V}; I_D = 25 \text{ A}; T_j = 25 ^{\circ}\text{C}$	-	27	32	mΩ
		$V_{GS} = 5 \text{ V}; I_D = 15 \text{ A}; T_j = 25 ^{\circ}\text{C};$ see Figure 12 and 13	-	25	30	mΩ
		$V_{GS} = 10 \text{ V}; I_D = 15 \text{ A}; T_j = 25 ^{\circ}\text{C}$	-	23	28	$m\Omega$
Source-dr	rain diode					
$V_{SD}$	source-drain voltage	$I_S = 25 \text{ A}; V_{GS} = 0 \text{ V}; T_j = 25 ^{\circ}\text{C};$ see <u>Figure 16</u>	-	0.85	1.2	V
t <sub>rr</sub>	reverse recovery time	$I_S = 20 \text{ A}$ ; $dI_S/dt = -100 \text{ A/}\mu\text{s}$ ;	-	101	-	ns
Q <sub>r</sub>	recovered charge	$V_{GS} = -10 \text{ V}; V_{DS} = 30 \text{ V};$ $T_j = 25 \text{ °C}$	-	115	-	nC
Dynamic o	characteristics					
$Q_{G(tot)}$	total gate charge	$I_D = 25 \text{ A}; V_{DS} = 60 \text{ V}; V_{GS} = 5 \text{ V};$	-	19	-	nC
$Q_{GS}$	gate-source charge	T <sub>j</sub> = 25 °C; see <u>Figure 14</u>	-	5	-	nC
$Q_{GD}$	gate-drain charge		-	9	-	nC
C <sub>iss</sub>	input capacitance	$V_{GS} = 0 \text{ V}; V_{DS} = 25 \text{ V};$	-	1550	2070	pF
C <sub>oss</sub>	output capacitance	f = 1 MHz; T <sub>j</sub> = 25 °C; see Figure 15	-	150	179	pF
C <sub>rss</sub>	reverse transfer capacitance		-	60	80	pF

Table 6. Characteristics ... continued

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$t_{d(on)}$	turn-on delay time	$V_{DS} = 30 \text{ V}; R_L = 1.2 \Omega;$	-	16	-	ns
t <sub>r</sub>	rise time	$V_{GS}$ = 5 V; $R_{G(ext)}$ = 10 Ω; $T_i$ = 25 °C	-	106	-	ns
t <sub>d(off)</sub>	turn-off delay time		-	51	-	ns
t <sub>f</sub>	fall time		-	83	-	ns

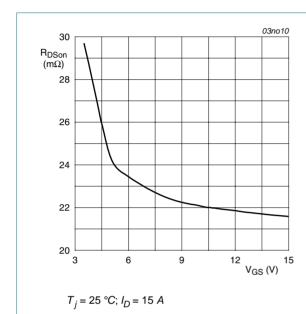
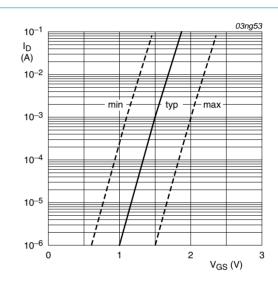


Fig 6. Drain-source on-state resistance as a function of gate-source voltage; typical values



 $T_j = 25 \, ^{\circ}C; V_{DS} = V_{GS}$ 

Fig 7. Sub-threshold drain current as a function of gate-source voltage

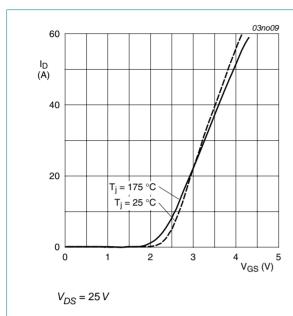


Fig 8. Transfer characteristics: drain current as a function of gate-source voltage; typical values

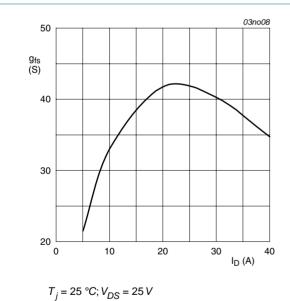
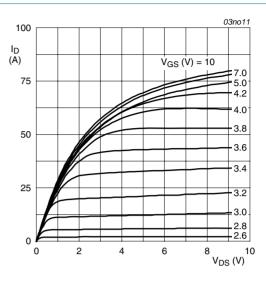
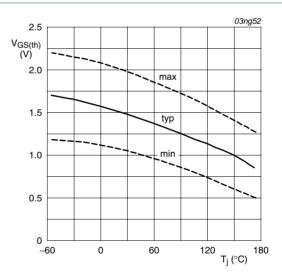


Fig 10. Forward transconductance as a function of drain current; typical values



$$T_i = 25$$
 °C;  $t_D = 300 \,\mu$ s

Fig 9. Output characteristics: drain current as a function of drain-source voltage; typical values



$$I_{D} = 1 \, mA; V_{DS} = V_{GS}$$

Fig 11. Gate-source threshold voltage as a function of junction temperature

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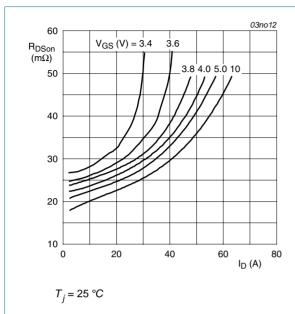


Fig 12. Drain-source on-state resistance as a function of drain current; typical values

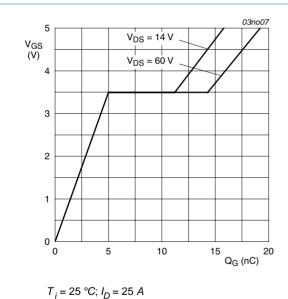
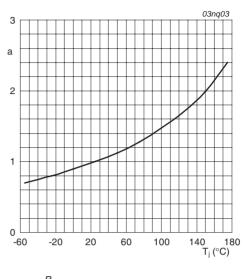
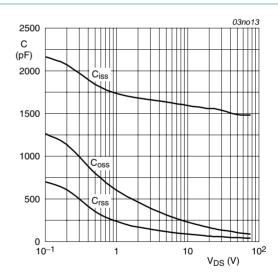


Fig 14. Gate-source voltage as a function of gate charge; typical values



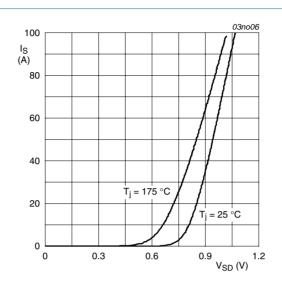
$$a = \frac{R_{DSon}}{R_{DSon(25^{\circ}C)}}$$

Fig 13. Normalized drain-source on-state resistance factor as a function of junction temperature



 $V_{GS} = 0 V$ ; f = 1 MHz

Fig 15. Input, output and reverse transfer capacitances as a function of drain-source voltage; typical values



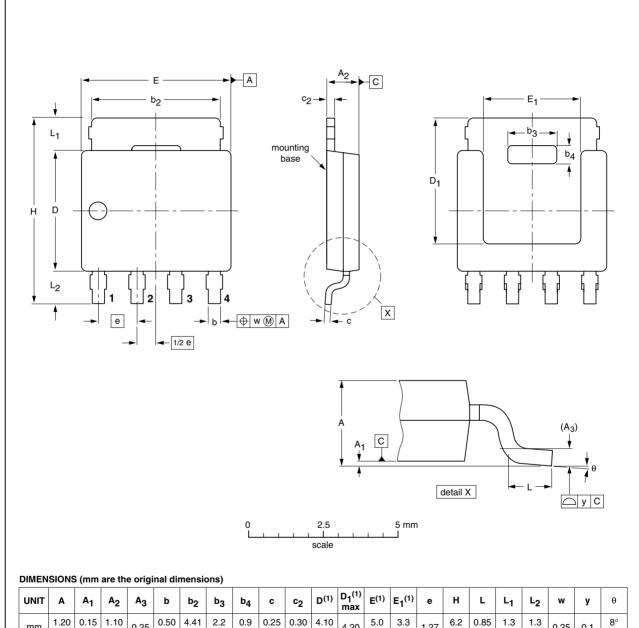
 $V_{GS} = 0 V$ 

Fig 16. Source current as a function of source-drain voltage; typical values

# Package outline

### Plastic single-ended surface-mounted package (LFPAK); 4 leads

**SOT669** 



UNIT	A	A <sub>1</sub>	A <sub>2</sub>	A <sub>3</sub>	b	b <sub>2</sub>	b <sub>3</sub>	b <sub>4</sub>	С	c <sub>2</sub>	D <sup>(1)</sup>	D <sub>1</sub> <sup>(1)</sup> max	E <sup>(1)</sup>	E <sub>1</sub> <sup>(1)</sup>	е	H	L	L <sub>1</sub>	L <sub>2</sub>	w	у	θ
mm	1.20 1.01	0.15 0.00	1.10 0.95	0.25	0.50 0.35	4.41 3.62	2.2 2.0	0.9 0.7	0.25 0.19	0.30 0.24		4.20	5.0 4.8	3.3 3.1	1.27	6.2 5.8	0.85 0.40	1.3 0.8	1.3 0.8	0.25	0.1	8° 0°

1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.

OUTLINE		REFER	EUROPEAN	ISSUE DATE			
VERSION	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE	
SOT669		MO-235				<del>04-10-13</del> 06-03-16	

Fig 17. Package outline SOT669 (LFPAK)

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## N-channel TrenchMOS logic level FET

# **Revision history**

### Table 7. **Revision history**

**Product data sheet** 

Document ID	Release date	Data sheet status	Change notice	Supersedes
BUK9Y30-75B_4	20080410	Product data sheet	-	BUK9Y30-75B_3
Modifications:	• <u>Figure 13</u> : ι	updated		
BUK9Y30-75B_3	20080222	Product data sheet	-	BUK9Y30-75B_2
BUK9Y30-75B_2	20060411	Product data sheet	-	BUK9Y30_75B-01
BUK9Y30_75B-01 (9397 750 13729)	20040714	Product data sheet	-	-

# 9. Legal information

### 9.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions"
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# **BUK9Y30-75B**

## N-channel TrenchMOS logic level FET

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